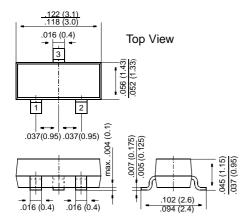
BC856 THRU BC859

Small Signal Transistors (PNP)

SOT-23



Dimensions in inches and (millimeters)

Pin configuration 1 = Base, 2 = Emitter, 3 = Collector.

FEATURES

 PNP Silicon Epitaxial Planar Transistors for switching and AF amplifier applications.



 Especially suited for automatic insertion in thick- and thin-film circuits.

- ◆ These transistors are subdivided into three groups A, B and C according to their current gain. The type BC856 is available in groups A and B, however, the types BC857, BC858 and BC859 can be supplied in all three groups. The BC859 is a low noise type.
- As complementary types, the NPN transistors BC846 ... BC849 are recommended.

MECHANICAL DATA

Case: SOT-23 Plastic Package Weight: approx. 0.008 g

Marking code

Туре	Marking	Туре	Marking
BC856A B BC857A B C BC858A B C	3A 3B 3E 3F 3G 3J 3K 3L	BC859A B C	4A 4B 4C

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified

		Symbol	Value	Unit
Collector-Base Voltage	BC856 BC857 BC858, BC859	-V _{CBO} -V _{CBO} -V _{CBO}	80 50 30	V V V
Collector-Emitter Voltage	BC856 BC857 BC858, BC859	-V _{CES} -V _{CES} -V _{CES}	80 50 30	V V V
Collector-Emitter Voltage	BC856 BC857 BC858, BC859	-V _{CEO} -V _{CEO}	65 45 30	V V V
Emitter-Base Voltage		-V _{EBO}	5	V
Collector Current		-I _C	100	mA
Peak Collector Current		-I _{CM}	200	mA
Peak Base Current		-I _{BM}	200	mA
Peak Emitter Current		I _{EM}	200	mA
Power Dissipation at T _{SB} = 50 °C		P _{tot}	3101)	mW
Junction Temperature		Tj	150	°C
Storage Temperature Range		T _S	-65 to +150	°C



BC856 THRU BC859

ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified

		Symbol	Min.	Тур.	Max.	Unit
h-Parameters at –V _{CE} = 5 V, –I _C = 2	mA f = 1 kHz					
Current Gain	Current Gain Group A B C	h _{fe} h _{fe} h _{fe}	_ _ _	220 330 600	- - -	
nput Impedance	Current Gain Group A B C	h _{ie} h _{ie} h _{ie}	1.6 3.2 6	2.7 4.5 8.7	4.5 8.5 15	kΩ kΩ kΩ
Output Admittance	Current Gain Group A B C	h _{oe} h _{oe} h _{oe}	_ _ _	18 30 60	30 60 110	μS μS μS
Reverse Voltage Trans		h _{re}	_	1.5 · 10-4	_	_
	Current Gain Group A B C	h _{re}	_ _	2 · 10 ⁻⁴ 3 · 10 ⁻⁴	- -	_ _ _
DC Current Gain at –V _{CE} = 5 V, –I _C = 1	Ο μΑ					
	Current Gain Group A B C	h _{FE} h _{FE} h _{FE}	- - -	90 150 270	_ _ _	- - -
at –V _{CE} = 5 V, –I _C = 2	Current Gain Group A B C	h _{FE} h _{FE} h _{FE}	110 200 420	180 290 520	220 450 800	_ _ _
Thermal Resistance J Backside	unction to Substrate	R _{thSB}	_	-	3201)	K/W
Thermal Resistance J	unction to Ambient Air	R _{thJA}	_	_	450 ¹⁾	K/W
Collector Saturation Vat $-I_C = 10 \text{ mA}, -I_B = 10 \text{ mA}$ at $-I_C = 100 \text{ mA}, -I_B = 100 \text{ mA}$	0.5 mA	−V _{CEsat} −V _{CEsat}		90 250	300 650	mV mV
Base Saturation Voltaget $-I_C = 10 \text{ mA}, -I_B = 10 \text{ mA}$ at $-I_C = 100 \text{ mA}, -I_B = 100 \text{ mA}$	0.5 mA	−V _{BEsat} −V _{BEsat}	_ _ _	700 900	_ _	mV mV
Base-Emitter Voltage at $-V_{CE} = 5 \text{ V}$, $-I_{C} = 2$ at $-V_{CE} = 5 \text{ V}$, $-I_{C} = 10$		−V _{BE} −V _{BE}	600 -	660 -	750 800	mV mV
Collector-Emitter Cuto at $-V_{CE} = 80 \text{ V}$ at $-V_{CE} = 50 \text{ V}$ at $-V_{CE} = 30 \text{ V}$ at $-V_{CE} = 80 \text{ V}$, $T_j = 12$ at $-V_{CE} = 50 \text{ V}$, $T_j = 12$ at $-V_{CE} = 30 \text{ V}$, $T_j = 12$ at $-V_{CB} = 30 \text{ V}$ at $-V_{CB} = 30 \text{ V}$, $T_j = 12$	BC856 BC857 BC858, BC859 25 °C BC856 25 °C BC857 25 °C BC858, BC859	-ICES	- - - - -	0.2 0.2 0.2 - - - -	15 15 15 4 4 4 15	nA nA nA μA μA μA μA
Gain-Bandwidth Produ		f _T	_	150	_	MHz

¹⁾ Device on fiberglass substrate, see layout

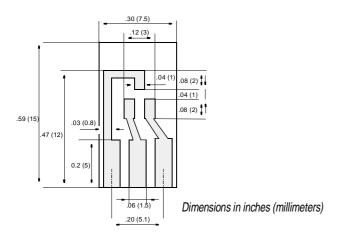


BC856 THRU BC859

ELECTRICAL CHARACTERISTICS

Ratings at 25 °C ambient temperature unless otherwise specified

	Symbol	Min.	Тур.	Max.	Unit
Collector-Base Capacitance at –V _{CB} = 10 V, f = 1 MHz	C _{CBO}	_	_	6	pF
Noise Figure at $-V_{CE}$ = 5 V, $-I_{C}$ = 200 μ A, R_{G} = 2 $k\Omega$, f = 1 kHz, Δ f = 200 Hz BC856, BC857, BC858 BC859	F F		2 1	10 4	dB dB
Noise Figure at $-V_{CE}$ = 5 V, $-I_{C}$ = 200 μ A, R_{G} = 2 $k\Omega$, f = 3015000 Hz BC859	F	_	1.2	4	dB



Layout for R_{thJA} test

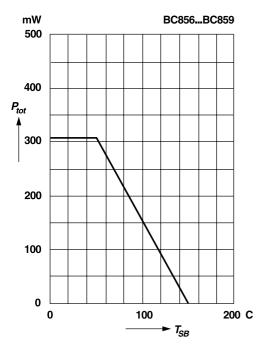
Thickness: Fiberglass 0.059 in (1.5 mm) Copper leads 0.012 in (0.3 mm)



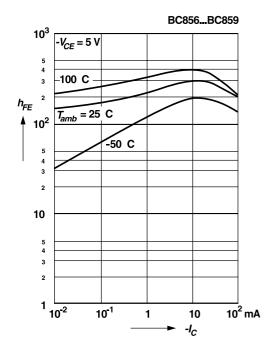
RATINGS AND CHARACTERISTIC CURVES BC856 THRU BC859

Admissible power dissipation versus temperature of substrate backside

Device on fiberglass substrate, see layout

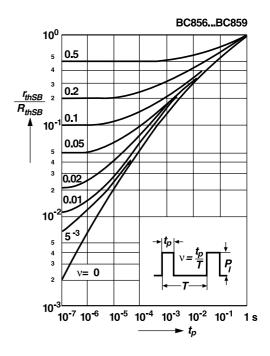


DC current gain versus collector current

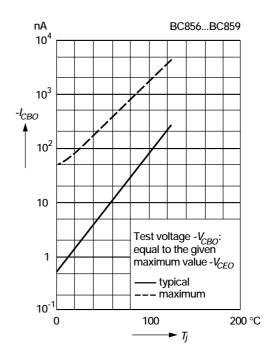


Pulse thermal resistance versus pulse duration (normalized)

Device on fiberglass substrate, see layout



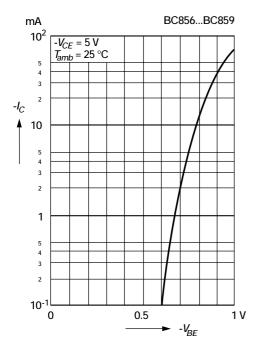
Collector-base cutoff current versus junction temperature



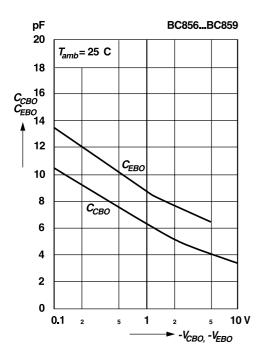


RATINGS AND CHARACTERISTIC CURVES BC856 THRU BC859

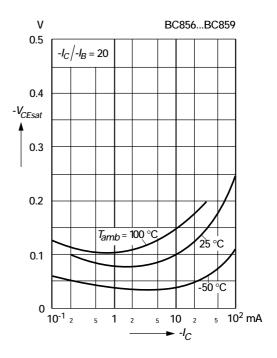
Collector current versus base-emitter voltage



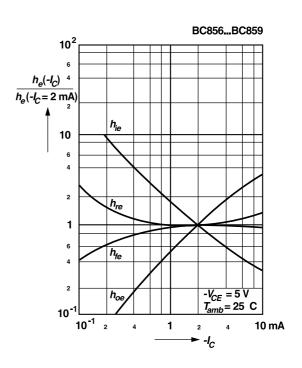
Collector-base capacitance, Emitter-base capacitance versus reverse bias voltage



Collector saturation voltage versus collector current



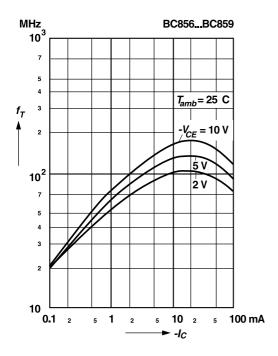
Relative h-parameters versus collector current



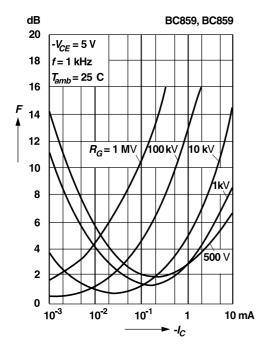


RATINGS AND CHARACTERISTIC CURVES BC856 THRU BC859

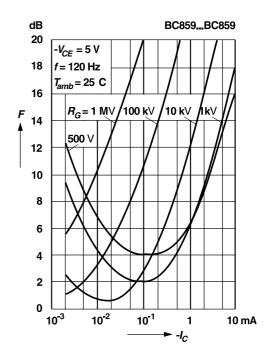
Gain-bandwidth product versus collector current



Noise figure versus collector current



Noise figure versus collector current



Noise figure versus collector-emitter voltage

